Government of India Bhabha Atomic Research Centre Control Instrumentation Division

Ref : CnID/AMIS/SCR/22/4/E-48904

Date : 10.06.2022

Sub: Minor Fabrication - Invitation of Quotation

Manufacturing, assembly, & supply of "Field deployable RF enclosure assemblies along with its internal modules casing assemblies" compliance to attached technical specification no. TSP/SCR/2022/001 dated 08/06/22, Rev.0 Dear Sir/Madam,

- 1. Quotations are invited for the manufacturing, assembly, & supply of "Field deployable RF enclosure assemblies along with its internal modules casing assemblies" compliance to attached technical specification no. TSP/SCR/2022/001 dated 08/06/22, Rev.0 Bidder shall quote for manufacture, assembly, inspection, testing and supply of the assemblies with material.
- 2. No Free Issue material is involved.
- 3. GST @5% will be applicable and GST certificate will be provided by BARC for the same.
- 4. The quotation should be submitted in two separate sealed envelopes, one is for price bid and other for technical bid. Both sealed envelope should be put in one single envelope and must reach to the Head, Control Instrumentation Division by 27/06/2022 (12:00 Noon). The single sealed envelope should be sent super scribed with the reference number & the due date given above. <u>The quotation must be sent by speed post/registered post only.</u>
- 5. The address on the envelop should read: The Head,

Control Instrumentation Division,

BARC, Trombay, Mumbai - 400 085.

(Kind Attn: S. C. Ramrane, SO/E)

- 6. The fabricator should prepare the fabrication drawings of the components & assembly and then get these approved by our engineer before starting the fabrication.
- 7. The fabrication work shall be subjected to stage wise inspection by our engineer. The finished components shall not be dispatched prior to approval by our engineer. Necessary inspection facilities should be provided to our engineer during fabrication at bidder's premises.
- 8. The bidder shall complete the job within **6 months** from the date of firm work order issued to the bidder. The finished components shall be delivered by the bidder at Control Instrumentation Division, BARC, Trombay, Mumbai 400 085.
- 9. Head, Control Instrumentation Division reserves the rights to accept / reject any or all quotations without assigning any reason.
- 10. Incomplete offer or offer received after the due date shall not be considered.
- 11. Delivery charges if any must be clearly mentioned in the offer. Quotation must indicate the validity of offer. Quotation must also indicate the GST no. and PAN no. of the party.
- 12. Drawings / Sketches must be returned along with the offer.
- 13. The quotation has to be signed by authorized person with company seal.
- 14. Payment will be made by online transfer only after satisfactory completion of work on production of bill, delivery challan and advance stamped receipt. It may be noted that TDS from GST@ 2% and IT @ 2% with surcharge on tax at applicable rates shall be deducted from your bills.
- 15. Procurement of all the Items mentioned in BOM (table-1), assembling and EMI/EMC, IP65 and temperature & humidity is completely in the scope of supplier.
- 17 The supplier should have previous experience of qualification and testing of enclosure for EMI/EMC, IP65 and temperature & humidity. The machining facility must be equipped with CNC VMC & HMC machine, Spark erosion EDM, wire EDM, Jig Boring, CNC Turning and other basic machines required for fabrication. Also the facility must be equipped with all the inspection facilities like 3D Coordinate measuring machine, profile projector, electronic height gauge and basic measuring instruments with valid calibration certificate. All the machining and inspection must be completed within a single premise/ facility for design security purpose.

Encl.:

- 1. Annexure-I (General Specifications) 1 sheet
- 2. Annexure-II (TSP No.: TSP/SCR/2022/001 dated 18/05/22, Rev.0) 5 sheets
- 3. Drawings A-EM-018-A3, F-RF-01-A3, F-TR-01-A3 & F-BB-01-A3 with BOM/detail dwgs.

Sd/-(**Smt. Anuradha Mayya**) Head, CnID

ANNEXURE-I (TSP No.: -TSP/SCR/2022/001 dated 08/06/22, Rev.0) General Specifications (No. of pages:1)

1.0 Quality surveillance, inspection and inspection report:

- 1.1 All work covered by the specifications shall be subject to quality surveillance by the purchaser or his authorised representatives for which purpose the fabricator shall allow access at all reasonable times during manufacture to:
- 1.1.1 The premises in which work is being carried out.
- 1.1.2 The drawings and / or tooling involved.
- 1.1.3 Gauges, instruments etc. required for inspecting the work.
- 1.2 Inspection and tests shall be carried out by the fabricator as per the requirements detailed in the drawings and these specifications.
- 1.3 The fabricator shall submit three copies of inspection reports to the purchaser for approval.

1.4 Components found unsatisfactory as to workmanship or material shall be removed by fabricator and replaced by components which are satisfactory.

1.5 The finished components shall not be despatched prior to approval by our engineer.

2.0 Raw Material :

2.1 The fabricator has to quote with material cost.

3.0 Delivery:

3.1 The bidder shall deliver the finished components within $\underline{6 \text{ months}}$ from the date of firm purchase order is issued to bidder to CnID, BARC, Mumbai-400085. In case any extension in the delivery period is required, the fabricator should submit a written request for the same before the expiry of work order. Any delay in delivery which is attributable to the fabricator is liable for LD to be imposed on the fabricator.

4.0 Sub Contract:

4.1 The fabricator shall not sub-contract any or all the work without written consent from the purchaser. The fabricator shall be responsible for all work of the sub contractor of the fabricator, if at all allowed by the purchaser.

5.0 Taxes:

5.1 GST @5% will be applicable and GST certificate will be provided by BARC for the same.

6.0 Excise duty: NA

7.0 Payment :

7.1 Payment will be made only after satisfactory completion of work and on production of bill, advance stamped receipt & Guarantee/Warrantee Certificate.

7.2 It may be noted that Income tax @ 2% and GST@2% will be deducted from your bill.

8.0 Confidentiality:

8.1 No party shall disclose any information to third party concerning the matters under this contract generally. In particular, any information identified as "PROPRIETARY" in nature by the disclosing party shall be kept strictly confidential by the receiving party and shall not be disclosed to any third party without the prior written consent of the original disclosing party.

8.2 "RESTRICTED INFORMATION" categories under section 18 of the Atomic Energy Act, 1962 and "OFFICIAL SECRETS" under section 5 of the official Secrets Act, 1923:-

Any contravention of the above mentioned provisions by any contractor, sub-contractor, consultant, advisor or the employees of a contractor will invite penal consequences under the aforesaid legislation.

8.3 Prohibition against the use of BARC's name without permission for publicity purposes:-

The contractor or sub-contractor, consultant, advisor or the employees engaged by the contractor shall not use BARC's name for Publicity purpose through any public media like press, radio, T.V. or internet without the prior written approval of BARC.

(vide circular ref: 2/Misc-9/Lgl/2001/92 dated April 30, 2001)

ANNEXURE-II ((TSP No.: -TSP/SCR/2022/001 dated 08/06/22, Rev.0 - 05 Pages)

Manufacturing, assembly, & supply of "Field deployable RF enclosure assemblies along with its internal modules casing assemblies" compliance to attached technical specification no. TSP/SCR/2022/001 dated 08/06/22, Rev.0

1.0 SCOPE OF WORK

- 1.1 This specification specifies the requirement for manufacture, assembly qualification testing and supply of "Field deployable RF enclosure assemblies along with its internal modules casing assemblies". General description and requirement of the above said items is given in para-2.0. The raw material requirements are given in para-4.0 and deliverables are given in para-5.0. Bill of material is given in drawing GA. The complete raw material procurement is in supplier's scope. The assembled components shall be properly packed and safely delivered to BARC.
- 1.2 The supplier should provide compatible gaskets and internal coating for EMI/EMC qualification of enclosure assemblies. The supplier should also make necessary arrangement of handle with PU cover on top and bottom of the enclosure.
- 1.3 Qualification for EMI/EMC, IP65 and temperature & humidity of the assembled enclosures with connectors and PCBs as mentioned in the clause 3.0, is also in the scope of the supplier.
- 1.4 Supplier has to carry out the assembly of mating components before supply. Supplier shall develop necessary tooling and gauges as required. Special tools if required shall be indicated in the offer and price shall be indicated in the offer price. These tools shall be supplied along with the finished components. 100% dimensional inspection should be carried out.

2.0 SPECIAL TECHNIACAL REQUIRMENTS DURING MANUFACTURE: -

- 2.1 The above mentioned components are to be manufactured to the tolerance as indicated in their respective drawings.
- 2.2The components should be machined in a single setting preferably in a CNC machine to get the required accuracy in general and geometric tolerances.
- 2.3 The surface finish value indicated in the drawings is RMS micrometer values. The surface finish values indicated shall be obtained by grinding on surface indicated. The bidder shall confirm in the quotation that the surface finish requirements indicated in the drawing will be met by him.
- 2.4 All the items including connectors and display unit should be mounted on the enclosure properly.
- 2.5The supplier should have previous experience of qualification and testing of enclosure for EMI/EMC, IP65 and temperature & humidity. The machining facility must be equipped with CNC VMC & HMC machine, Spark erosion EDM, wire EDM, Jig Boring, CNC Turning and other basic machines required for fabrication. Also the facility must be equipped with all the inspection facilities like 3D Coordinate measuring machine, profile projector, electronic height gauge and basic measuring instruments with valid calibration certificate. All the machining and inspection must be completed within a single premise/ facility for design security purpose.

3.0 GENERAL DESCRIPTION AND REQUIREMENT

3.1 The entire work includes manufacturing, 100% inspection, assembly and supply of components of "EMI-EMC, temperature & humidity compliant and IP65 compatible RF enclosure assemblies along with Casing assemblies". The fabricator has to ensure proper machining within close tolerances mentioned in drawings of each part and inspection report, test certificate should be submitted before supply. The supplier has to understand the given requirements before starting the components assembly work. Final acceptance of components of "EMI-EMC, temperature & humidity compliant and IP65 compatible RF enclosure assemblies along with Casing assemblies" as per the quality acceptance plan given under clause 9.0 of same annexure.

- 3.2 RF enclosure assemblies should be compliance for IP 65.
- 3.3 EMI/ EMC Compatibility:
- 3.3.1 All systems should be subjected (type test) to Radiated Electromagnetic test field strength of 3 V/m as per IEC 61000-4-3 and Conducted Electromagnetic test noise signal level of 3 VRMS as per IEC 61000-4-6.
- 3.3.2 Conductive and Radioactive Emission Tests as per IEC 61000-6-4 should be performed on each subsystem.
- 3.3.3 Electrostatic Discharge Immunity Test as per IEC 61000-4-2 should be performed on each subsystem.
- 3.3.4 For RF system enclosure assembly, MIL-461 and JS-55555 standard should be performed.
- 3.4 Complete unit should be qualified for sr. no. 3.2 after fixing the connector and PCBs.
- 3.5 Chromatization / anodizing in required colour (will be mention in Work order) will be done all around on all the casings assemblies.
- 3.6 Internal coating and gaskets to be provided for qualifying the enclosure for above mentioned EMI/EMC tests.
- 3.7 Mounting arrangement to PCBs should be made inside box as per instructions. Required hardware/screws are also in the scope of supplier.
- 3.8 Your quotation should include the Qualification test for EMI/EMC as per mentioned standard above for each design.
- 3.9 Details of components are given in attached BOM in drawings for all assemblies.
- 3.10 Engraving/screen printing will be required for naming title on the face of each casing assembly and details will be provided at the time of work order.
- 3.11 Powder coating in required colour (will be mention in Work order) will be done all around on all the RF enclosure Assemblies.

4.0 RAW MATERIAL REQUIREMENT:

4.1 Raw materials including connectors and display unit as per bill of material given in attached drawing shall be purchased by supplier as per the standard specifications. Raw material to be purchased from reputed vendor only. No component should be fabricated from old, unused or scarp material stocks.

5.0 DELIVERABLES:

S. No.	Component	Drg No.	Q'ty
with its	acturing, assembly, & supply of "Field deple s internal modules casing assemblies" complia P/SCR/2022/001 dated 08/06/22, Rev.0:		
1	Field Deployable RF Enclosure Assembly	A-EM-018-A2	03 Ass'ly
2	RF Power Supply Module Casing Assembly	F-RF-01-A3,	03 Ass'ly
3	6U Transceiver Module Casing Assembly	F-TR-01-A3	03 Ass'ly
4	3U Baseband Module Casing Assembly	F-BB-01-A3	18 Ass'ly

6.0 PRICE:

6.1 The supplier shall give the lump sum price for full scope of work with its delivery schedule.

7.0 MANUFACTURE AND WORKMANSHIP:

- 7.1 The manufacturing process and workmanship shall be in accordance with high grade industrial practice and the best approved methods and shall be adequate to achieve accuracy and finish in accordance with drawings and this specification to ensure satisfactory operation and service life of various parts. Manufacturing process shall ensure the interchangeability of parts.
- 7.2 Geometrical and dimensional tolerances (if specified) at the respective locations shall be maintained strictly as per the drawing.
- 7.3 Immediately after all final machining operations, the components shall be thoroughly debarred and cleaned with Acetone (except Polyurethane parts) to remove all traces of cutting oils, cutting chips etc. After cleaning operations, the components shall be applied with rust free preventives (if necessary) and stored in heat sealed polythene pouches till they are up for final inspection and assembly.
- 7.4 If supplier wants to use any jigs and fixtures for the manufacture, same shall be approved by the purchaser before commencement of production. Supplier shall prepare quality control sheets for various stage of manufacturing and same shall be approved by the purchaser and will be used by third party/ BARC QS. Mutually agreed functional testing procedure and acceptance criteria shall be worked out, if required.
- 7.5 A care for cleanliness is to be maintained during assembly and storage of components. A complete record of assembly and subassembly checks is to be carried out. For this purpose a checklist is needed to be maintained for counter verification of the finished / completed jobs, required for assembly.

8.0 TOOLING

8.1 All tools like taps, dies, inspection gauges, etc., required for manufacture shall be arranged by the supplier.

9.0 FUNCTIONAL AND INSPECTION TESTS REPORTS

- 9.1 Supplier shall perform all necessary inspection and testing necessary as per the drawings and technical specification to the satisfaction of the purchaser. Supplier shall arrange and /or provide all testing and inspection facilities (gauges, instruments, equipments etc.) required during manufacture of the components, assembly, and shop testing of components. Only calibrated and approved facilities shall be employed for the inspection.
- 9.2 A systematic record of all inspection and testing carried out by the Supplier shall be maintained and offered to the representative of the Purchaser for review from time to time. Supplier shall make available necessary arrangement and facility to carry out spot inspection at random by the purchaser or his representative at any convenient time mutually agreed upon by the two parties
- 9.3 The facilities and procedures for inspection and testing shall ensure cleanliness, protection against damage to the equipment and shall comply with applicable 'Industrial Safety Codes'.
- 9.4 A compliance certificate for EMI/EMC, IP65 and temperature & humidity shall be issued by the supplier indicating conformance to the technical specifications with permissible deviation if any as agreed by the purchaser.

10.0 QUALITY ACCEPTANCE PLAN (QAP)

Following are quality acceptance plan for the component assembly job under this minor fabrication job:

- **10.1 Inspection-** After fabrication, all the components are required to inspect for dimensional accuracy as per drawing and assembly requirement.
- **10.2 Qualification testing-** All RF enclosure assemblies will be tested i,e "EMI-EMC, temperature & humidity compliant and IP65" as per standard mentioned in the para 3.0 (General description and requirement). Indentor will be available at the supplier's premises to witness all the tests. All test reports will be handed over to indentor by the supplier also.
- 10.3 After the inspection and qualification tests the assembled enclosure assemblies will be given to the indenter for final testing. If any component or assembly defects are noticed during testing in our lab the supplier will correct the same free of cost. Final delivery can be made after specified qualification testing. Final acceptance of all the assembled enclosure assemblies will be given by the indenter after complete functional testing.

11.0 QUALITY SURVEILLANCE

- 11.1 Quality surveillance and expediting, relating to all the aspects of the contract will be carried out by the purchaser or his authorized representative, for which purpose the supplier and his subcontractor shall allow access to the premises in which the work is being carried out, during manufacture, assembly and testing.
- 11.2 Furnish the latest drawings and/or tooling, gauges, instruments, testing equipment etc. required for inspecting the jobs. Prints of all the latest required drawings and approved procedures shall be made available for inspection and retention, if so desired.
- 11.3 Produce an inspection plan to the purchaser's satisfaction and notify when checkpoints on the plan are imminent so that the purchaser's representative may be present to witness the inspection, if it is so desired.
- 11.4 The supplier shall be responsible for the inspection and subsequent acceptance of the components that is subcontracted by him.
- 11.5 Waiving of quality surveillance by the purchaser's acceptance of the items by the purchaser or his authorized agent, shall not relieve the supplier from his responsibility for supplying the items in accordance with specification requirements of this document and purchase order.
- 11.6 Final acceptance of all Components of "EMI-EMC, temperature & humidity compliant and IP65 compatible RF enclosure assemblies along with Casing assemblies" will be given by the indenter after complete inspection and testing.

12.0 SUBCONTRACTING

12.1 The supplier shall not sub-contract any or all the work without the written consent from the purchaser.

13.0 SHIPMENT

- 12.1 CLEANING: The finish component before packing shall be degreased and cleaned.
- 13.2 PACKAGING: After completion of all testing and identifying the components, the components shall be packed suitably for shipment, so that no damage occurs in transit. The purchaser shall subject the packing procedure to prior approval. At least one copy of packing list shall be kept in the package for quick and easy verification.
- 13.3 Delivery: Delivery of subassemblies shall be made only after obtaining approval in all respect from purchaser. Completed jobs shall be delivered on or before the stipulated delivery period mentioned in Purchase Order/Work Order.

14.0 GUARANTEE / WARRANTY:

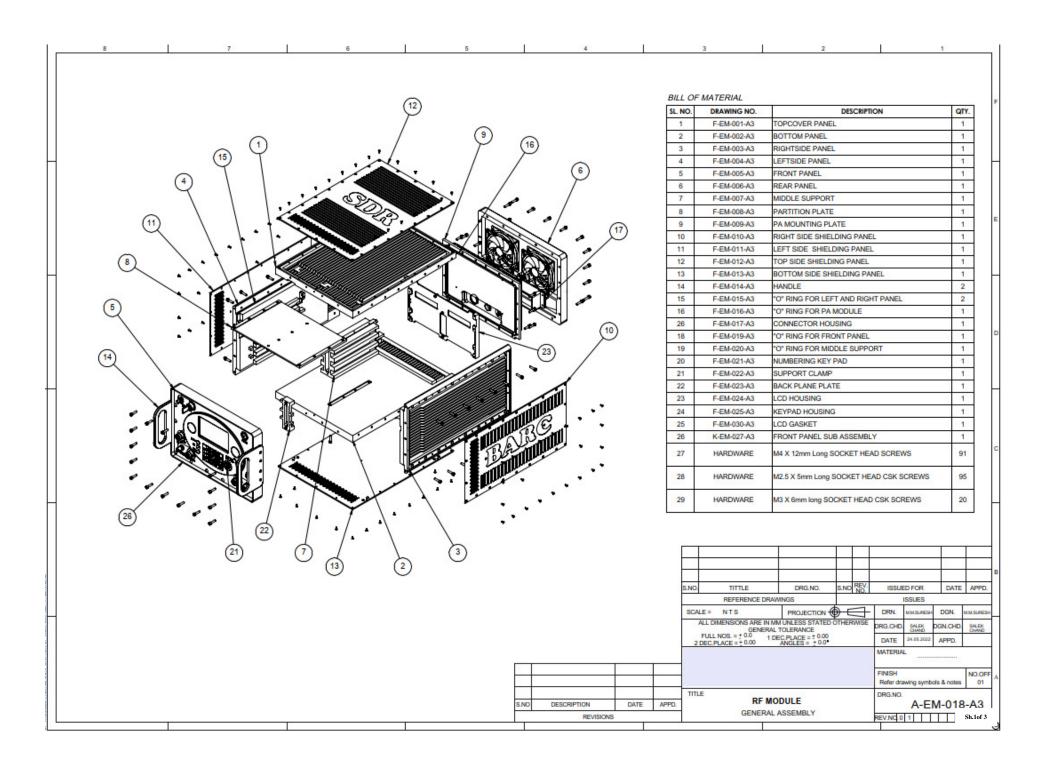
14.1 All fabricated components and assemblies under purchase order/work order shall be guaranteed for a period of 12 months from the date of delivery at purchaser's works.

15.0 PURCHASER'S DRAWINGS, SPECIFICATIONS ETC.:

- 15.1 Purpose: All drawings, specifications, free issue items etc. that may be provided to Supplier by Purchaser are the property of Purchaser and are intended to be complementary and to provide for and comprise everything necessary for the completion of works/supply. These are not to be used for any works or performance other than those for which these have been provided and shall be returned to Purchaser immediately on completion of work/supply, in good condition.
- 15.2 Property of Purchaser: If during the process of execution of the contract, any improvement, refinement or technical changes and modifications are effected by Supplier, such changes shall not affect the title to the property of Purchaser and all the information, specifications, drawings etc including the improvement/ modifications effected by Supplier shall continue to be the property of Purchaser. Supplier shall not have any claim or rights whatsoever in respect of purchaser's drawings, specifications, prototypes etc. even where improvement, refinement, modifications etc. have been effected by Supplier.

16.0 INFORMATION / DOCUMENTS TO BE FURNISHED ALONG WITH THE FINISHED COMPONENTS:

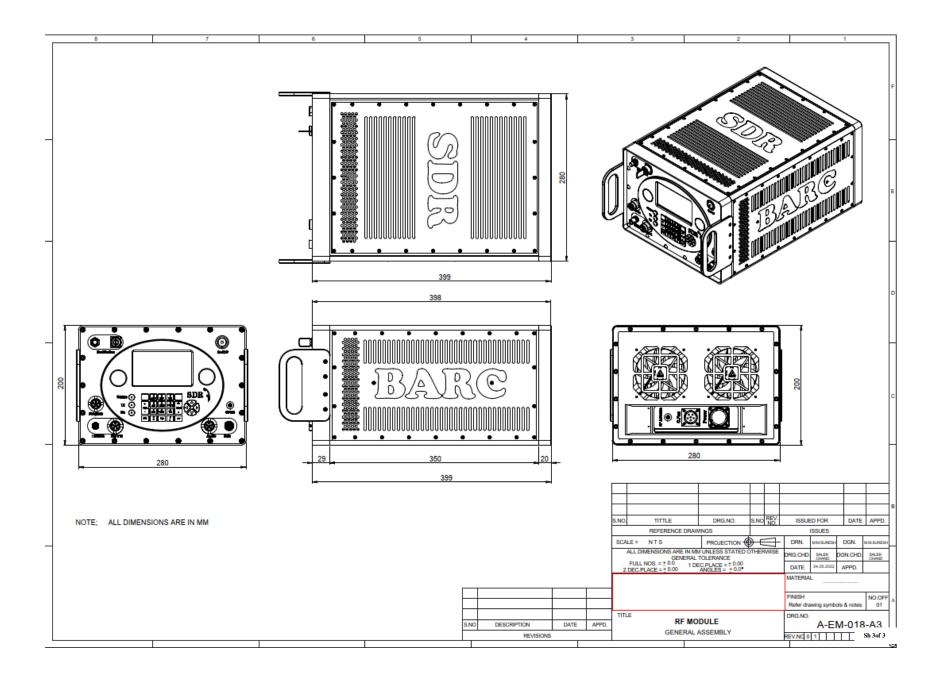
- 1. Two copies of dimensional inspection & report
- 2. Certificate of compliance to IP65, temp. humidity & EMI/EMC
- 3. Packing list
- 4. Delivery Challan
- 5. Invoice
- 6. Bank account details for NEFT/RTGS
- 7. Guarantee/ Warrantee certificate for 12 months
- 8. GST submission to authority undertaking
- 9. As built drawings
- 10. ITR Filing / Submission report

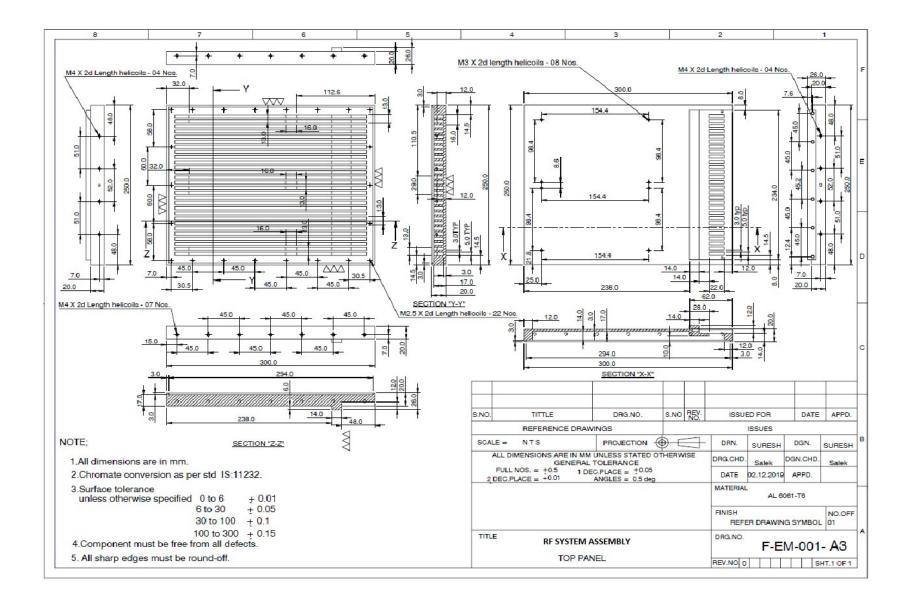


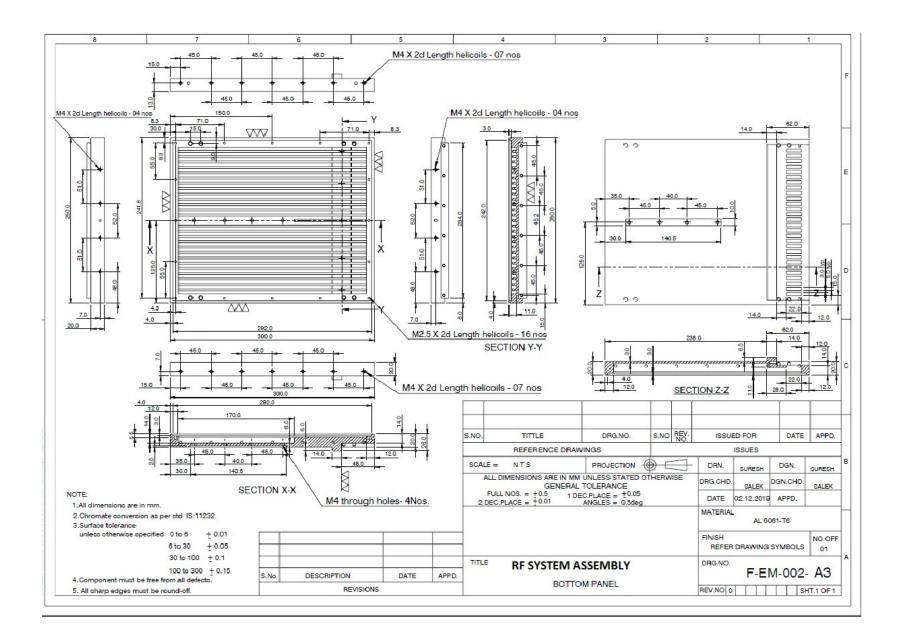
S.N.	Part Name	Part No. / Drawing No.	Manufacturer	Qty/ass'ly (Nos)	Total Qty for 3 ass'ly (Nos)
1.	RF System Enclosure Assembly Drawing	Total pages = 22		(1.02)	<u> </u>
	1) RF System Enclosure Assembly	A-EM-018-A3	To be fabricated	1	3
	2) Top panel	F-EM-001-A3	To be fabricated	1	3
	3) Bottom panel	F-EM-002-A3	To be fabricated	1	3
	4) Right side panel	F-EM-003-A2	To be fabricated	1	3
	5) Left side panel	F-EM-004-A2	To be fabricated	1	3
	6) Front panel	F-EM-005-A2	To be fabricated	1	3
	7) Rear panel	F-EM-006-A3	To be fabricated	1	3
	8) Middle support	F-EM-007-A3	To be fabricated	1	3
	9) Partition plate	F-EM-008-A3	To be fabricated	1	3
	10) PA mounting panel	F-EM-009-A2	To be fabricated	1	3
	11) Left side shielding panel	F-EM-010-A3	To be fabricated	1	3
	12) Right side shielding panel	F-EM-011-A3	To be fabricated	1	3
	13) Top panel shielding panel	F-EM-012-A3	To be fabricated	1	3
	14) Bottom shielding panel	F-EM-013-A3	To be fabricated	1	3
	15) Carrying Handle	F-EM-014-A3	To be fabricated	2	6
	16) "O" ring for left & right side panel	F-EM-015-A3	To be fabricated	2	6
	17) "O" ring for PA mounting panel	F-EM-016-A2	To be fabricated	1	3
	18) Connector housing	F-EM-017-A2	To be fabricated	1	3
	19) "O" ring for Front Panel	F-EM-019-A3	To be fabricated	1	3
	20) "O" ring for middle support	F-EM-020-A3	To be fabricated	1	3
	21) Numbering Key pad	F-EM-021-A3	To be fabricated	1	3
	22) Support Clamp	F-EM-022-A2	To be fabricated	1	3
					3
	23) VHB Waterproof Gasket for display	H16SCA23	To be fabricated	1	-
2.	Socket head CSK screws M2.5x6mm machine screw	STD.		78	234
3.	Socket head screws M4x10mm machine screw	STD.		88	264
4.	Socket head CSK screws M3x8mm machine screw	STD.		24	72
5.	M4 narrow spring washer	STD.		56	168
6.	6 -pin U329 circular connector	AJ-146, Audio Jack	Amphenol Nexus	3	9
7.	19-pin Circular Connector	UR01W11 F019P BK1 E1AB	Fischer Connector	1	3
8.	SMA 4 Hole Panel Receptance	132146	Amphenol Nexus	1	3
9.	Type N RF connector	31-6600	Amphenol RF	1	3
10.	On/Off rugged button with LED	Series 57, 57-112R	IWT Switches	1	3
11.	RED button	13000X778 series	APM	1	3
12.	Key Switch	IDEC-LB1K-2ST5B-1H	IDEC	1	3
13.	i-Button	UR01W08 F002S BK1	Fischer	1	3
14.	LCD Display Unit	AC043NB01	Mitsubishi	1	3
15.	Mil grade circular connector	D38999/20WE26SN	SOURIAU	1	3
16.	Mil grade circular connector (Pin) compatible for D38999/20WE26SN connector	D38999/26WE26PN	SOURIAU	1	3
17.	Mil grade circular connector	D38999/20WC35SN	SOURIAU	1	3
18.	Mil grade circular connector (Pin) compatible for D38999/20WC35SN connector	D38999/26WC35PN	SOURIAU	1	3
19.	Wedge lock for PCB fitting for 3U & 6U size	STD	STD	2	6
20.	DC Axial Cooling Fan 96.4 CFM (92x92x20.5mm)	09225VA-12Q-AA	NMB Technologies Corporation	2	6
21.	System status LED	QRM85BXXG02E	APEM Inc	3	9

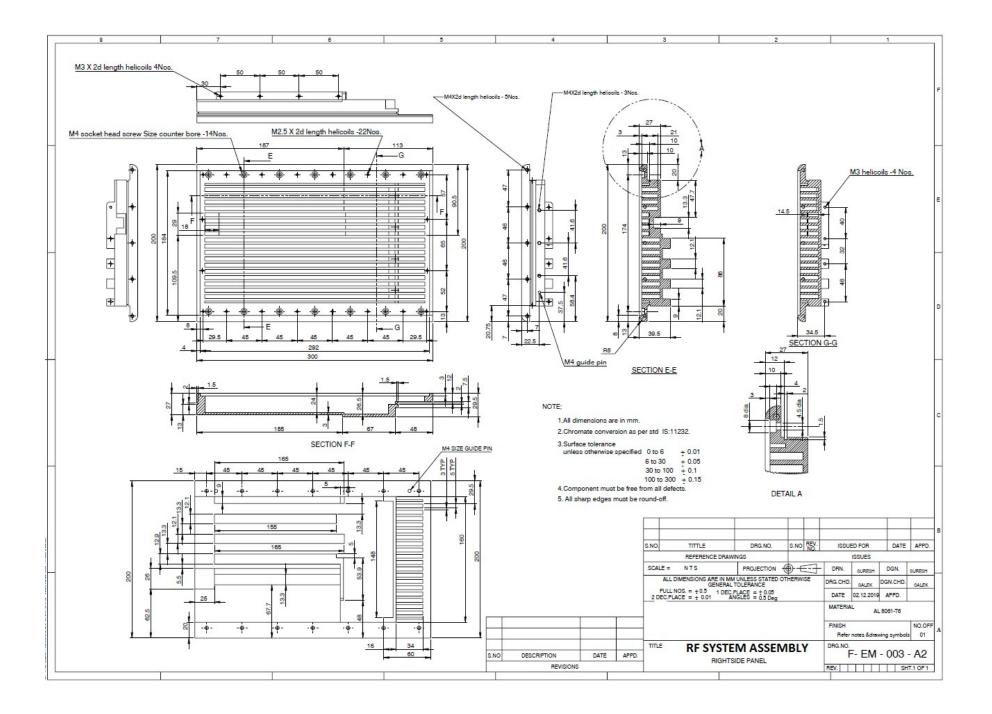
Bill of Material for GA Drawing No. A-EM-018-A3

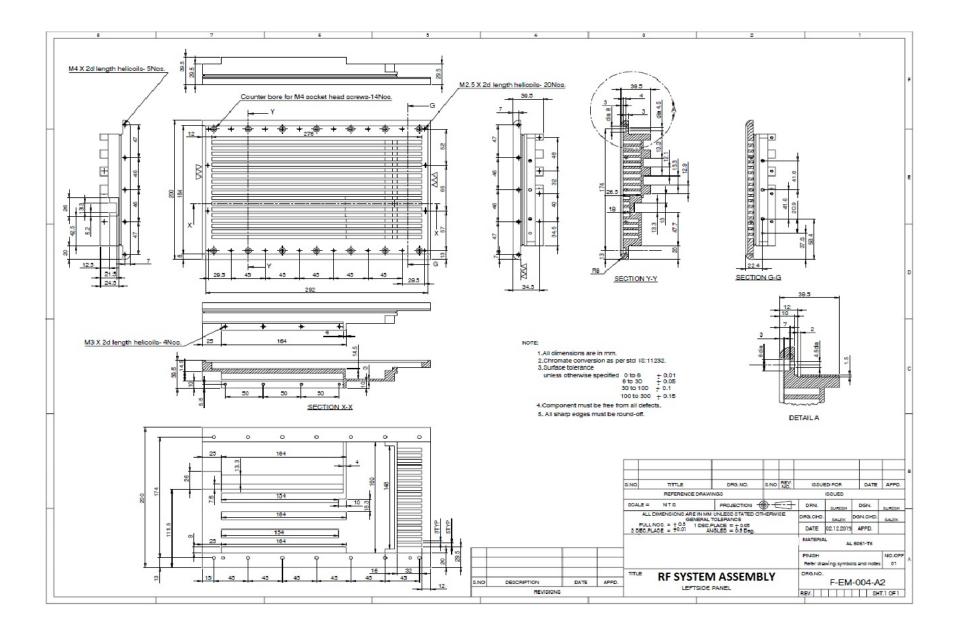
Drawing No.A-EM-018-A3

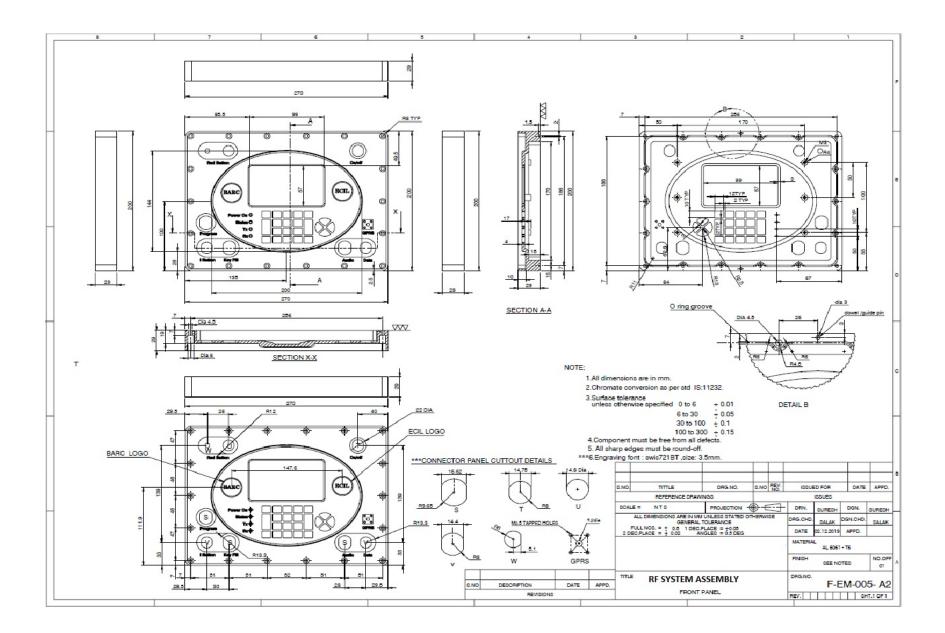


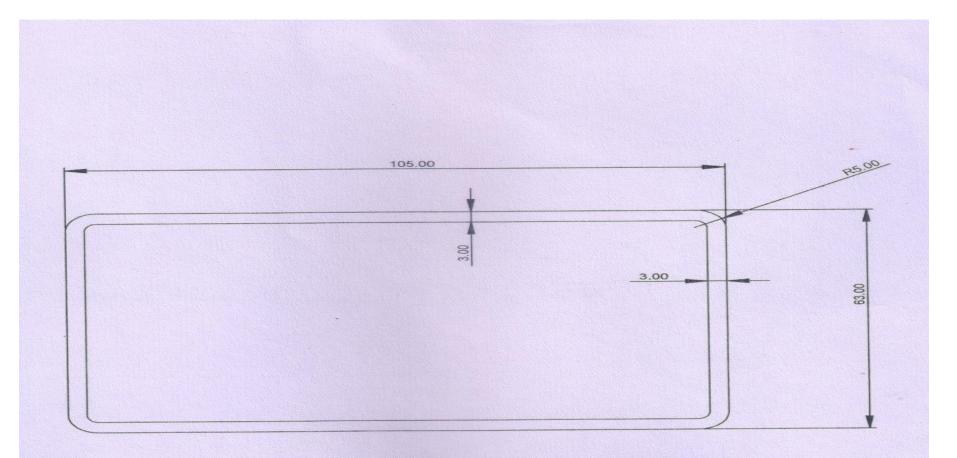






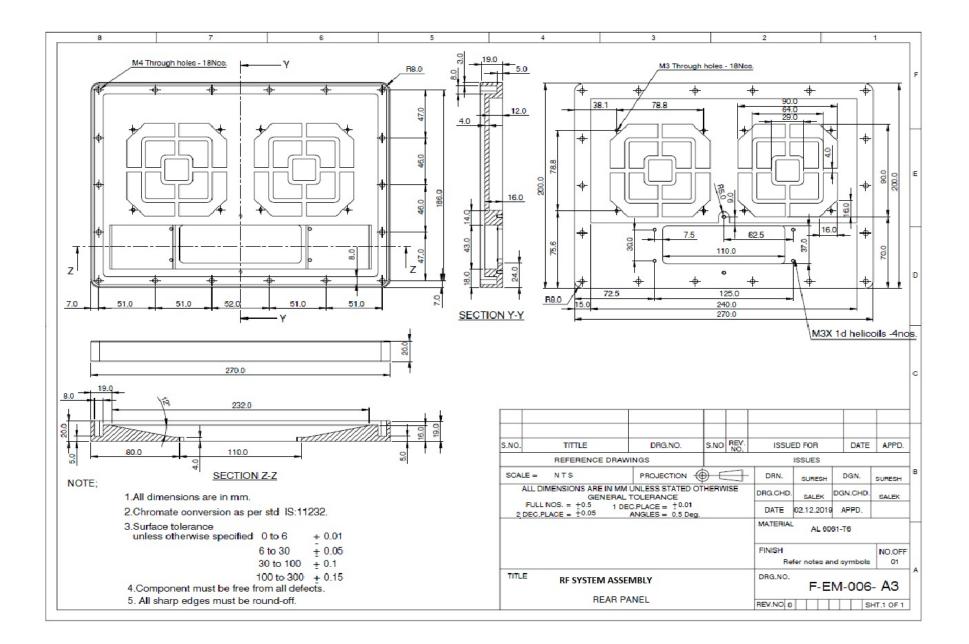


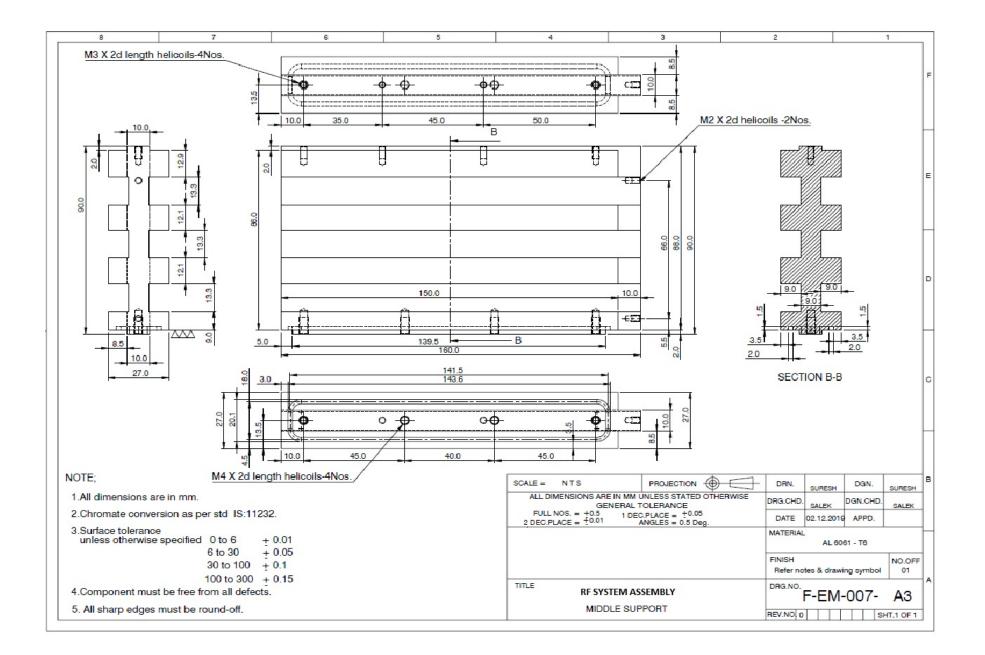


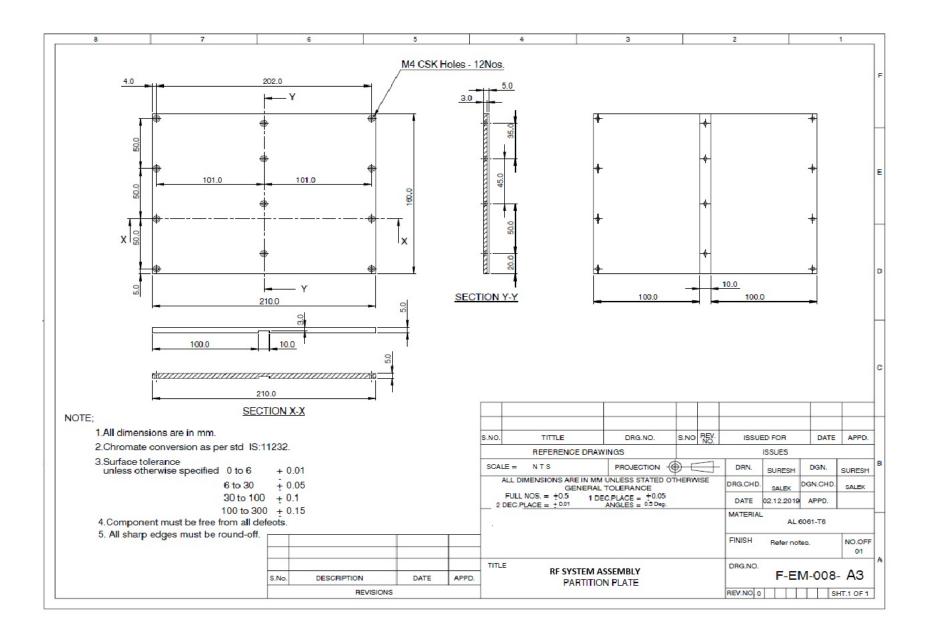


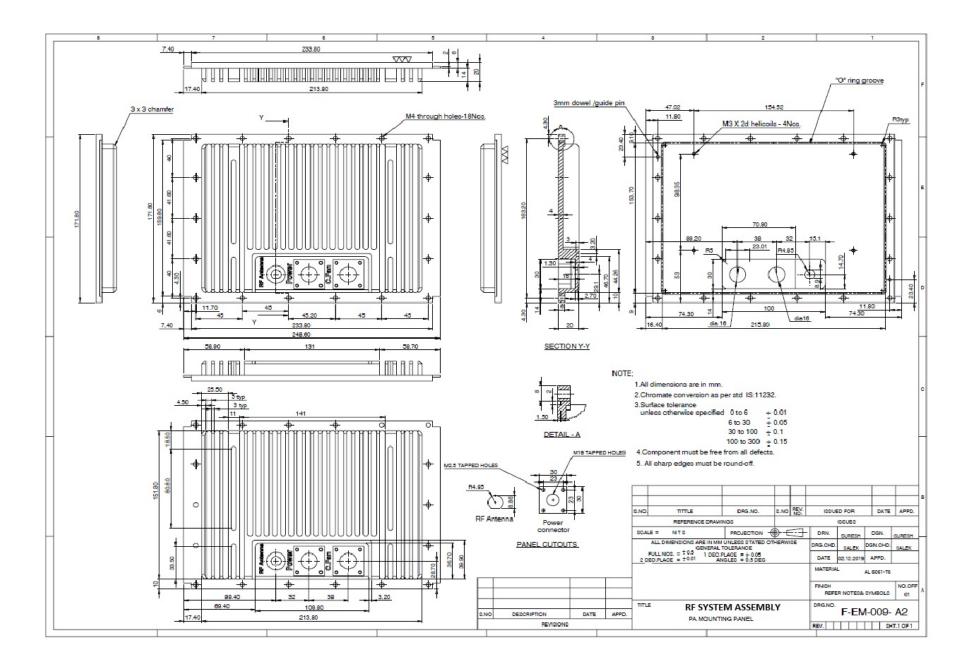
1mm Thick 3M VHB Water proof gaskets for display

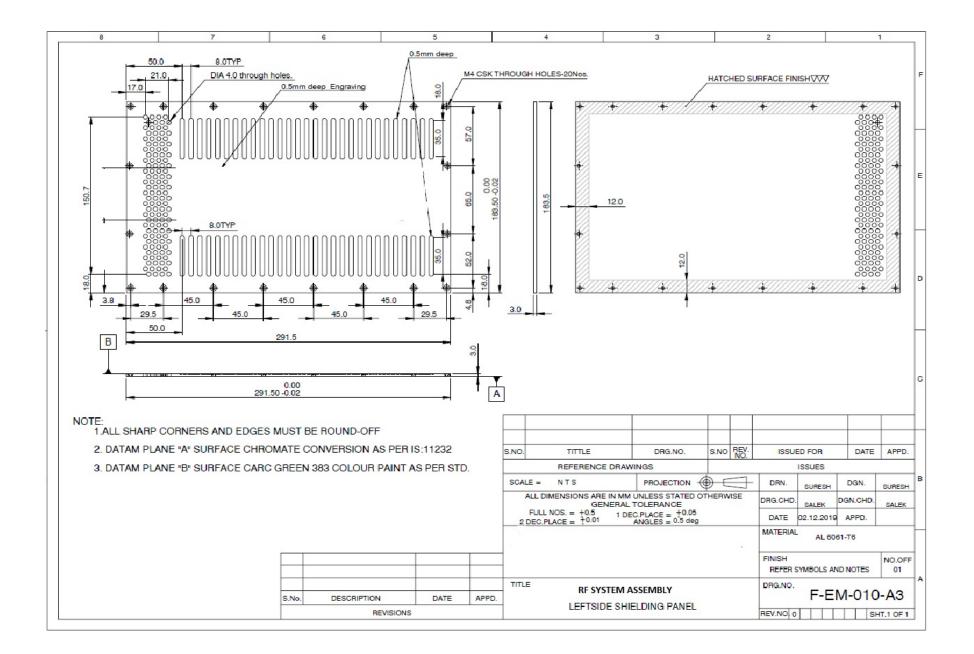
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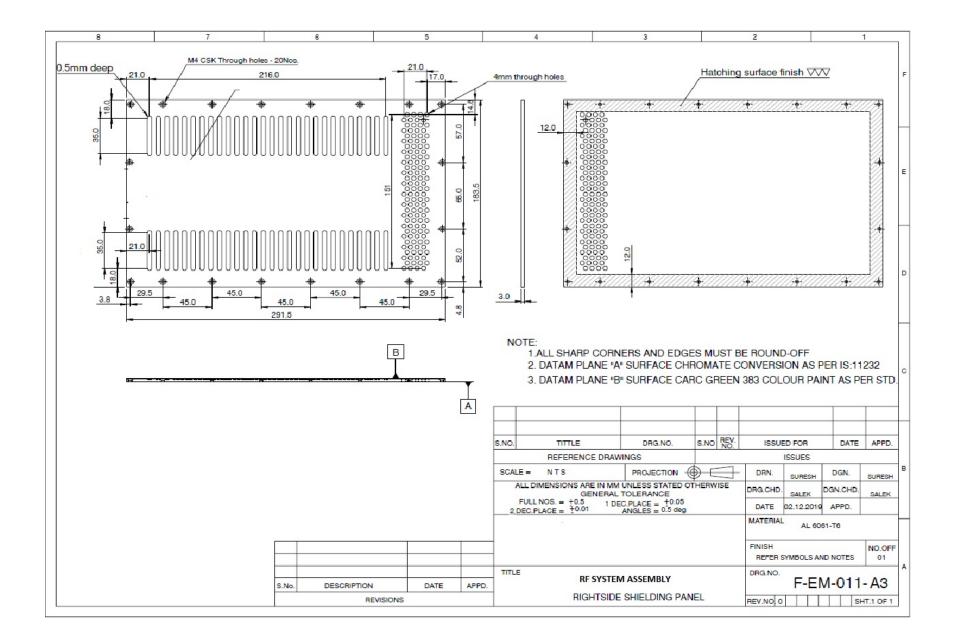


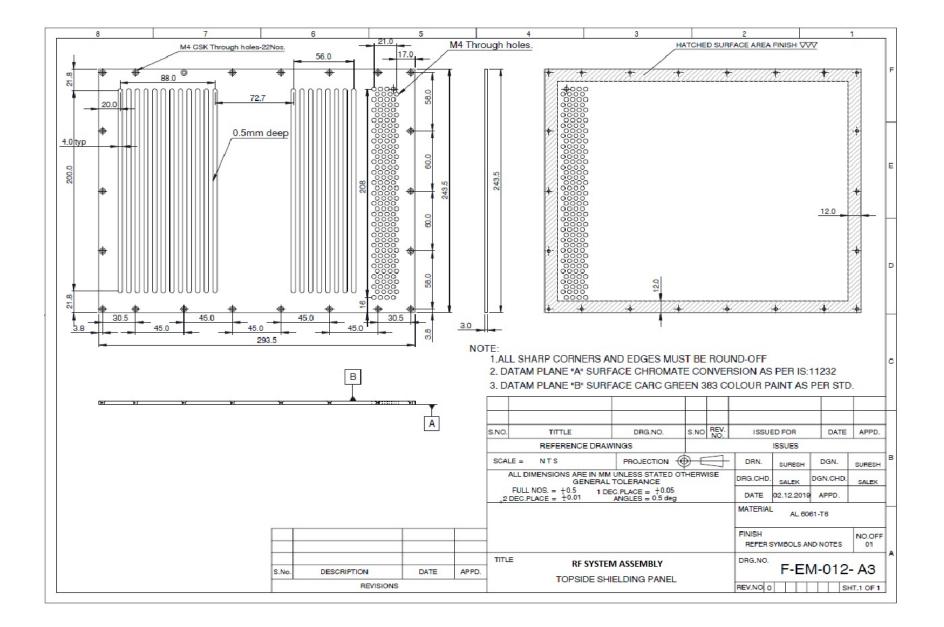


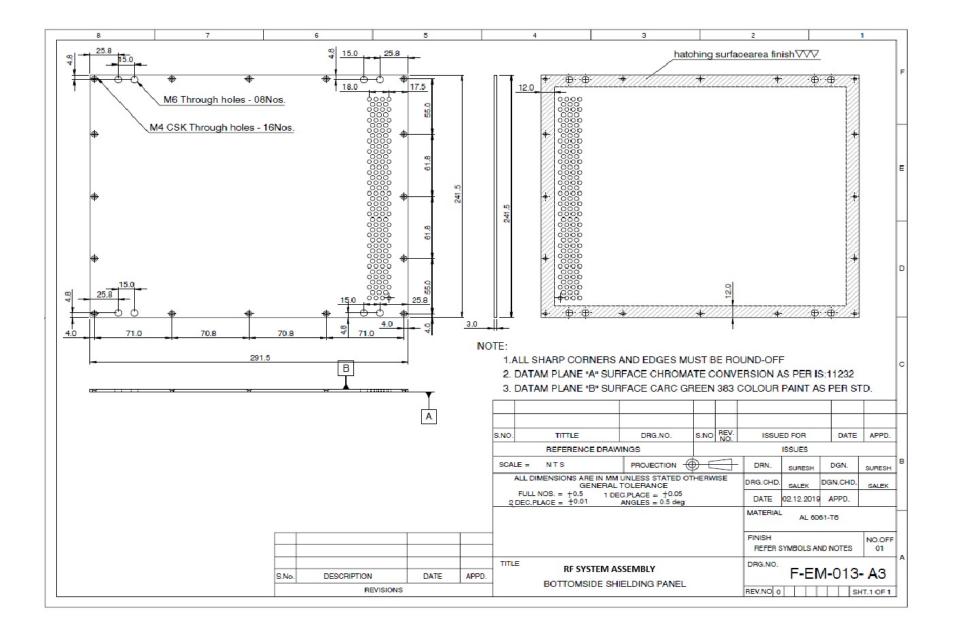


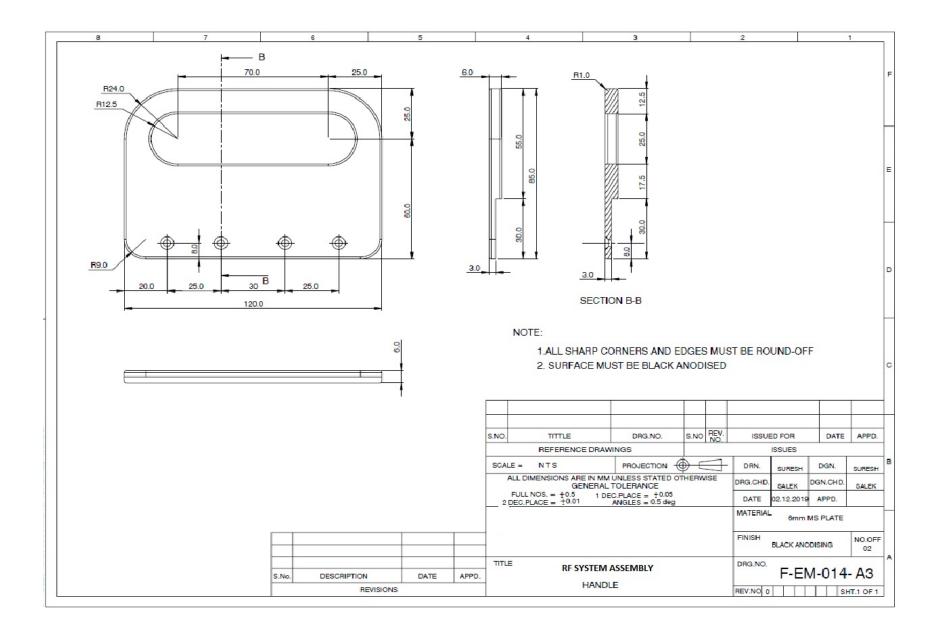


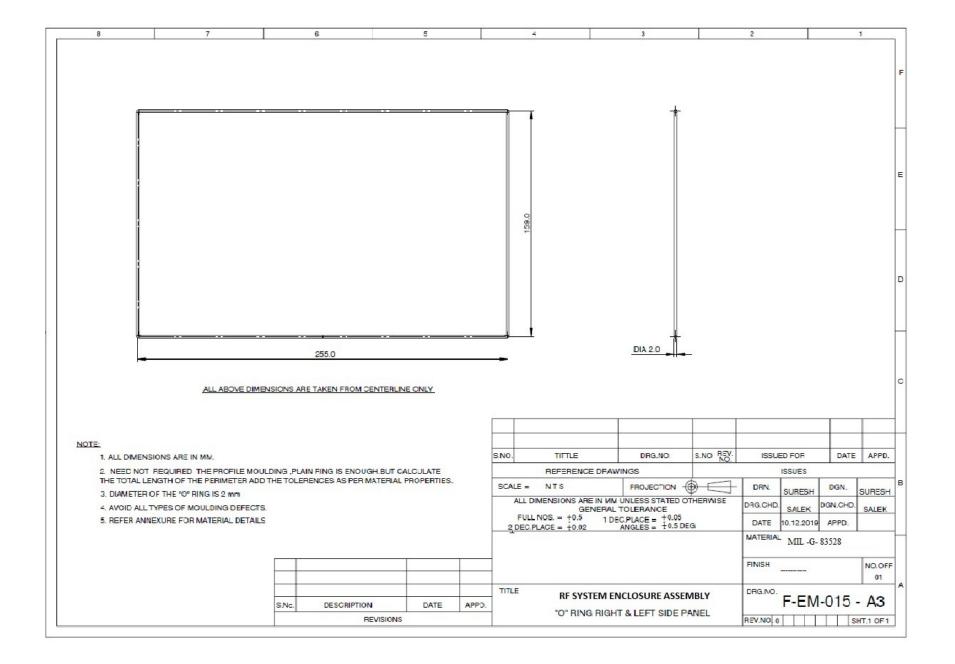


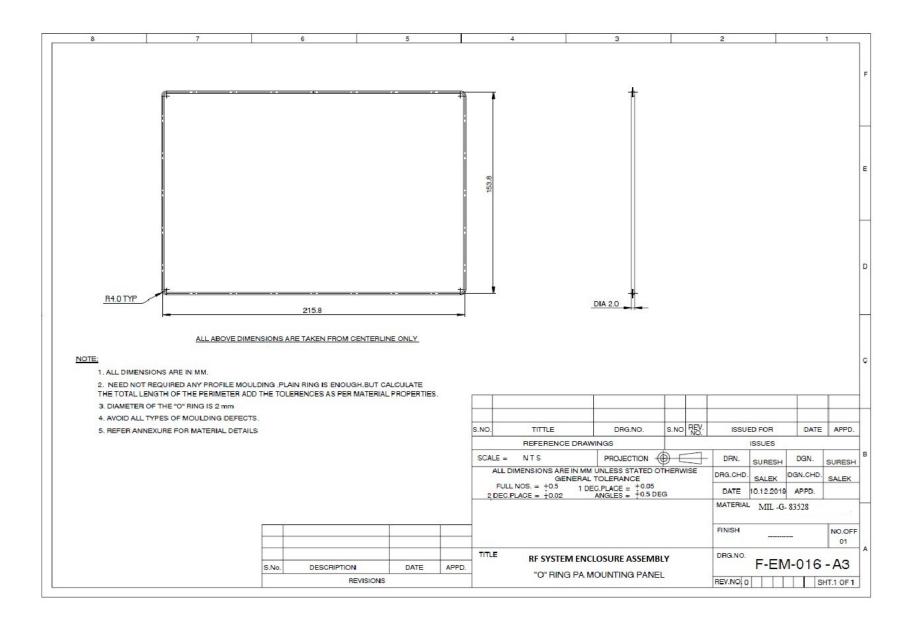


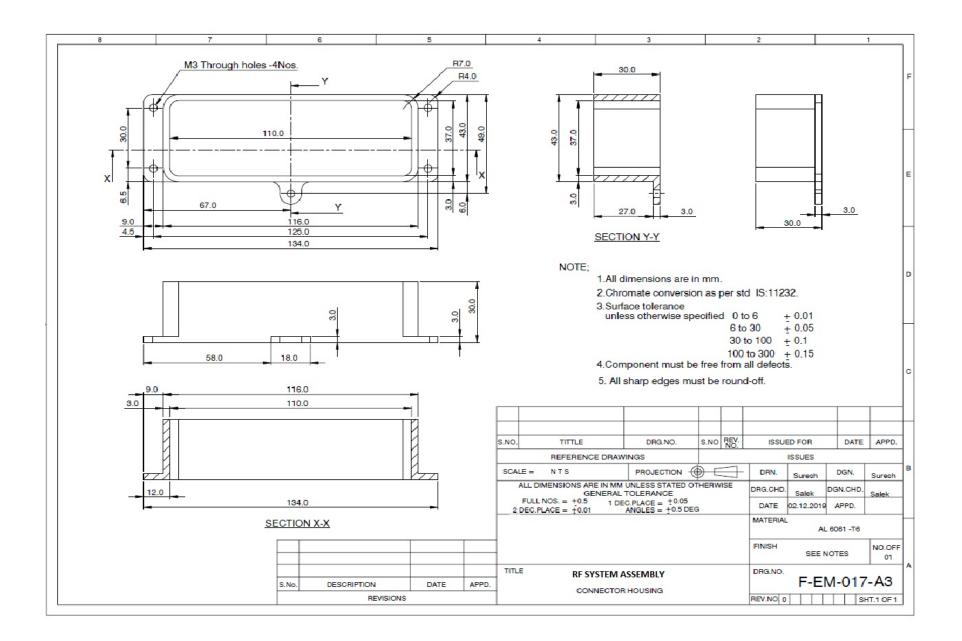


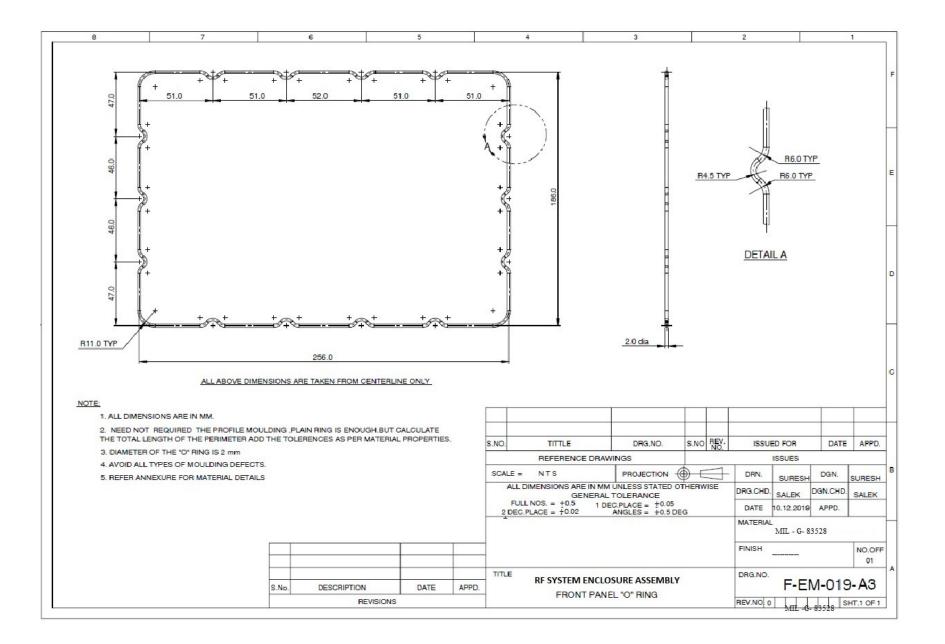


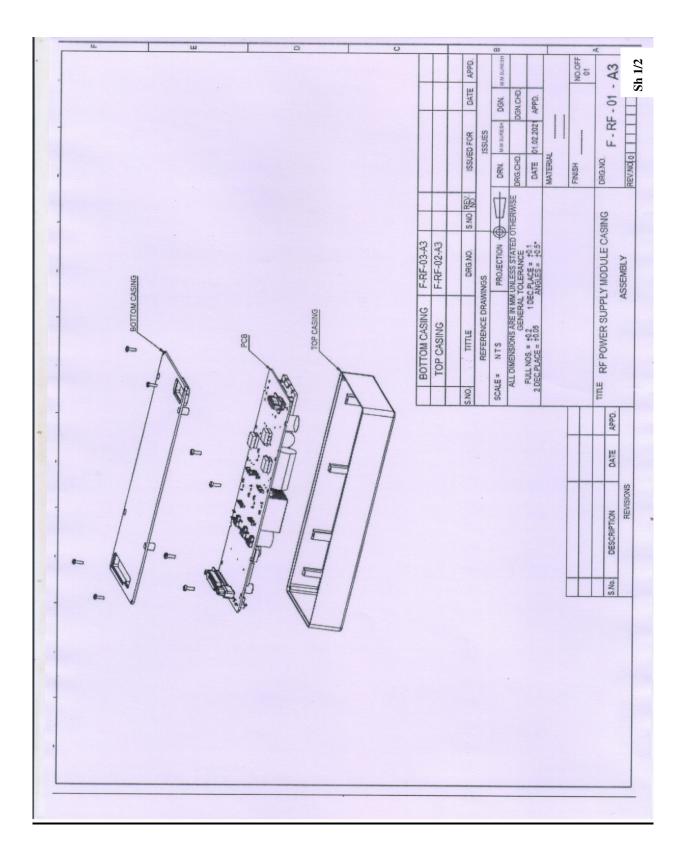










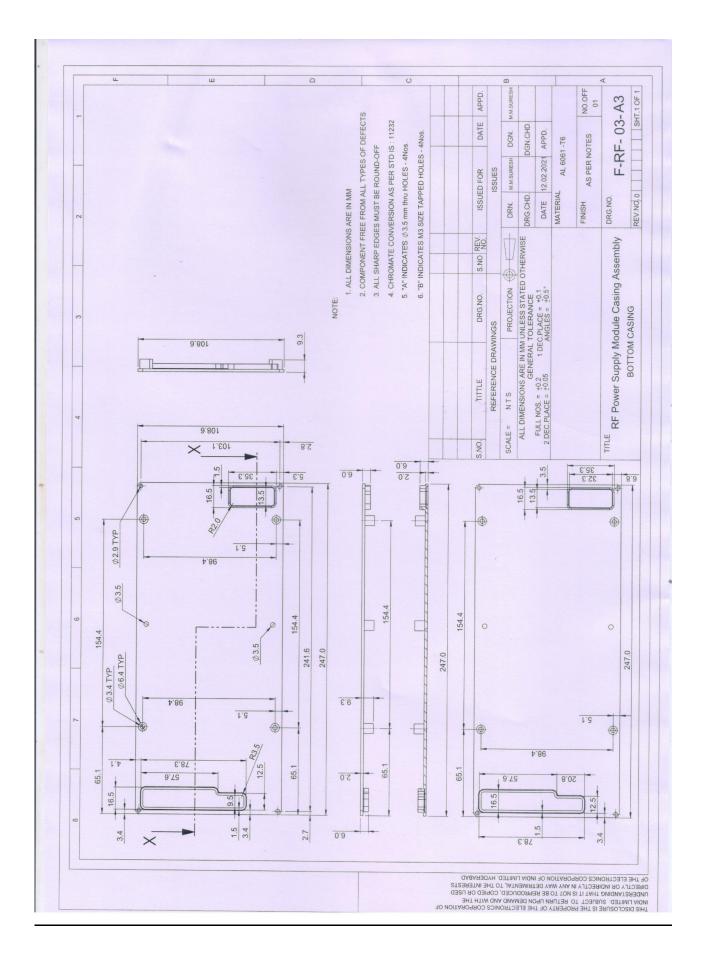


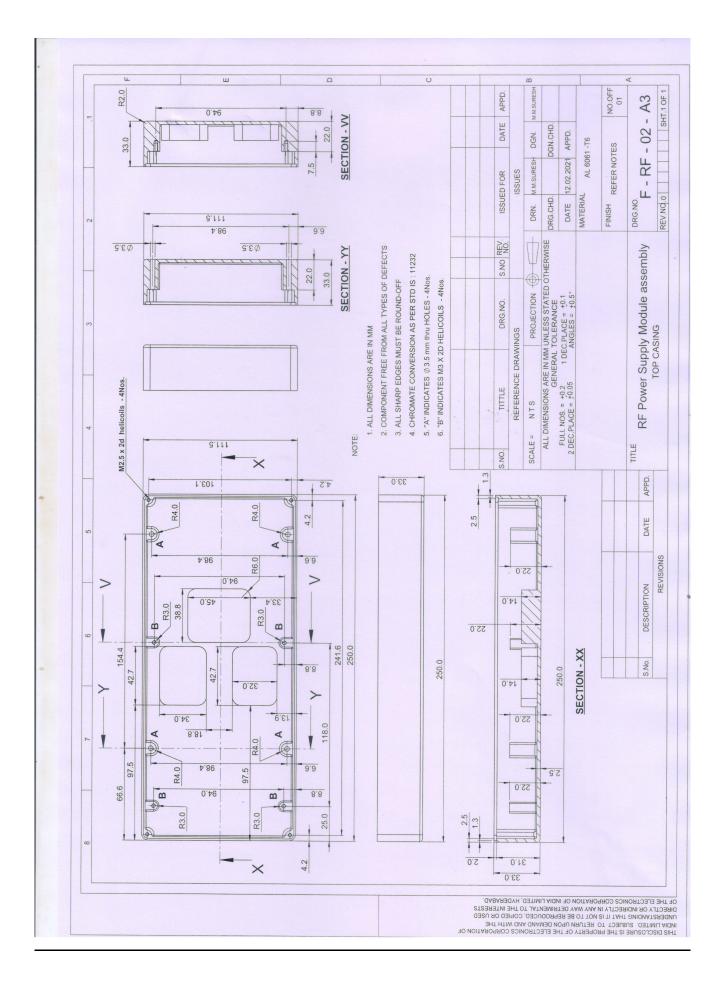
Bill of Material for GA Drawing No. A-RF-01-A3

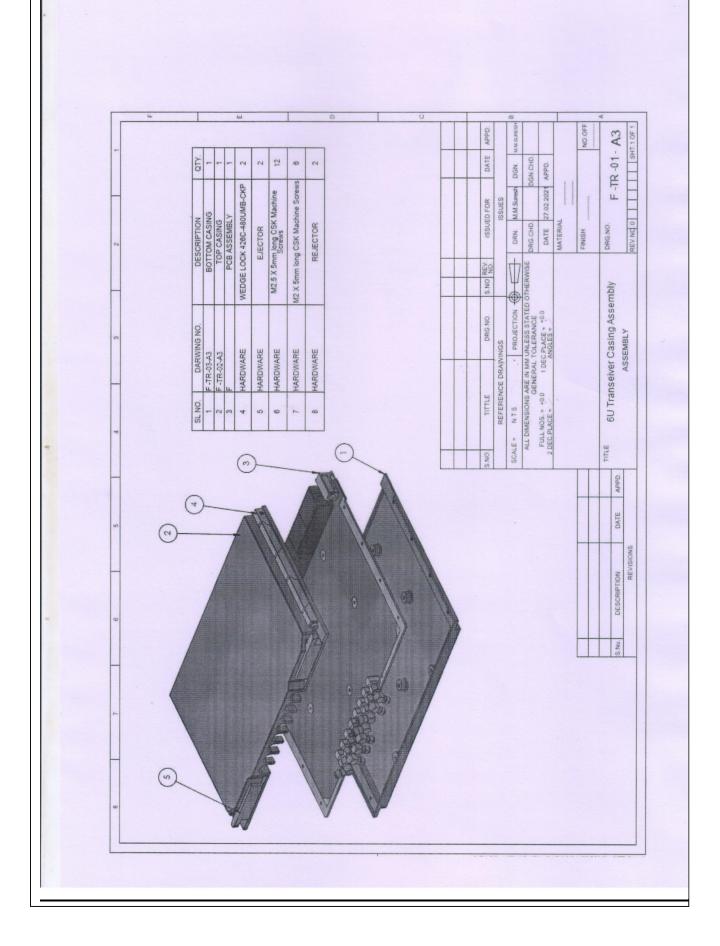
S.N.	Part Name	Part Name Part No. / Drawing No. Manufa		Qty/ass' ly (Nos)	Total Qty for 3 ass'ly (Nos)
1.	RF Power Supply Module Casing Assembly (With <u>Chromatization</u>)	Total pages = 4			
	1) RF System Enclosure Assembly	F-RF-01-A3	To be fabricated	1	3
	2) Bottom casing	As per Drg. No. F-RF-03-A3	To be fabricated	1	3
	3) Top casing	As per Drg. No. F-RF-02-A3	To be fabricated	1	3
2.	Socket head CSK screws M2.5x6mm machine screw	STD.		8	24
3.	Socket head CSK screws M3x8mm machine screw	STD.		8	24
4.	M4 narrow spring washer	STD.		8	24
5.	Cho-Therm High Power Insulator Pads. Make-Parker (Part no. 61-12- 0808-1671)	STD	M/s Parker Chometics	1/3	1
6.	Anabond 652c, 100 gram heat sink compound	STD	NA	2	6
7.	LED Panel Mount Indicators	PM3HDLW9.0	BIVAR	2	6

Drawing No.A-RF-01-A3

Sheet 2 of 2





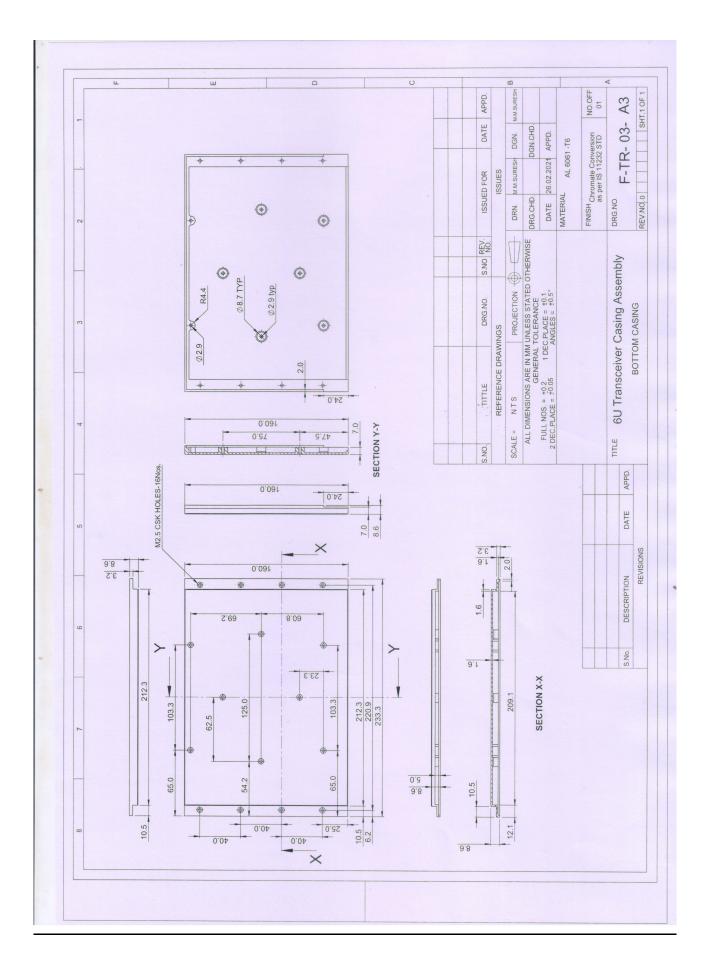


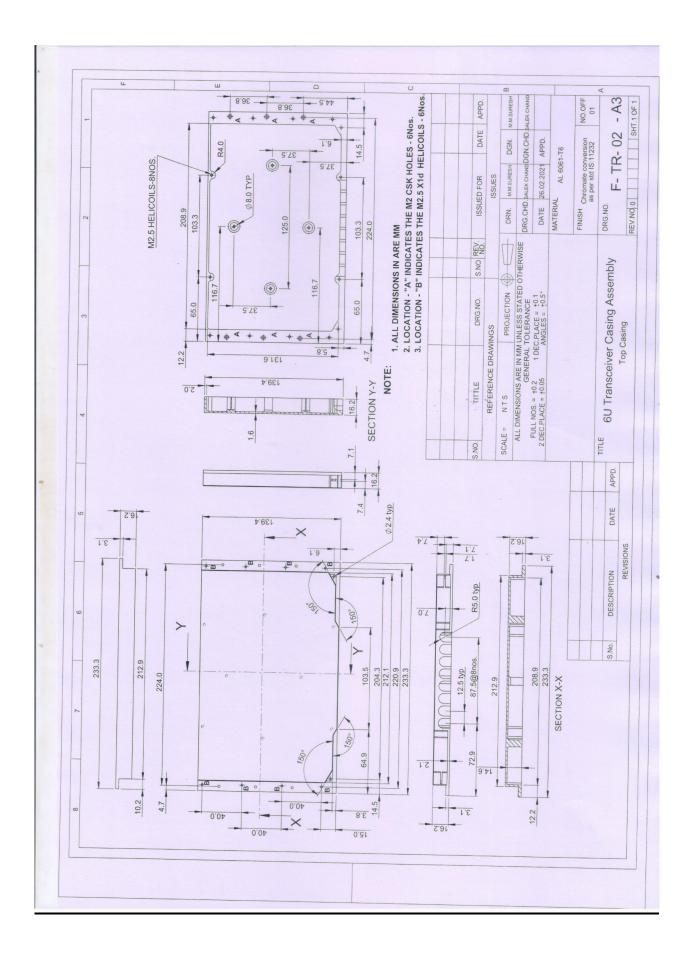
Bill of Material for GA Drawing No. A-TR-01-A3

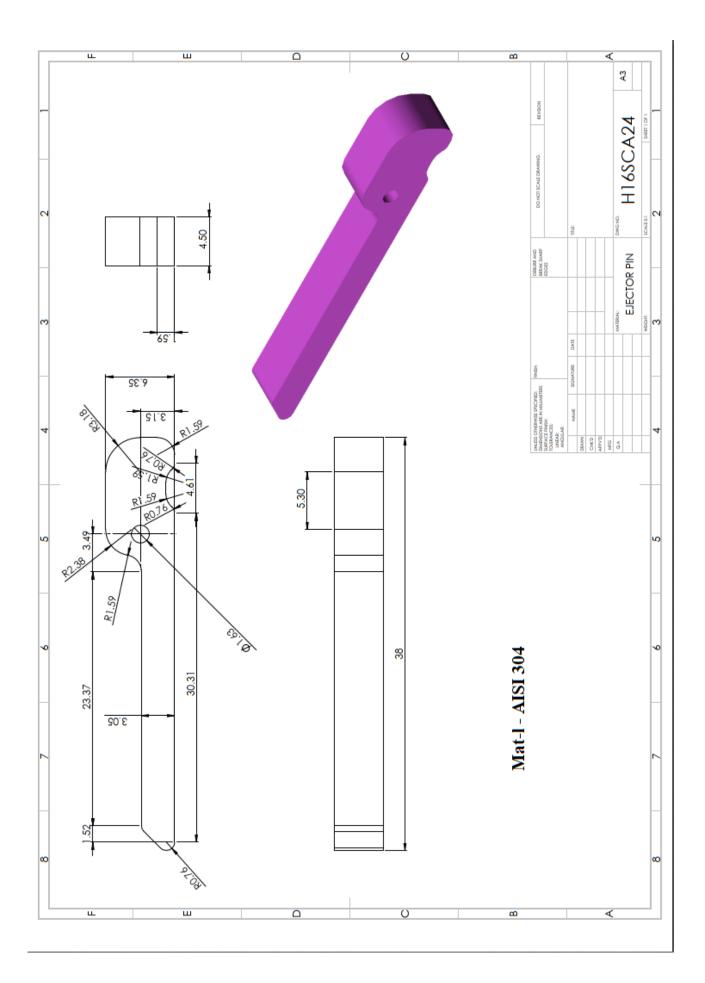
S.N.	Part Name	Part No. / Drawing No.	Manufacturer	Qty/ass? ly (Nos)	Total Qty for 3 ass'ly (Nos)
1.	6U Transceiver Module Casing Assembly (With <u>Chromatization</u>)	Total pages = 5			
	1) RF System Enclosure Assembly	F-TR-01-A3	To be fabricated	1	3
	2) Bottom casing	As per Drg, No. F-TR-03-A3	To be fabricated	1	3
	3) Top casing	As per Drg, No. F-TR-02-A3	To be fabricated	1	3
	Ejector pins	As per Drg. No. H16SCA24	To be fabricated	2	6
2.	Socket head CSK screws M2.5x6mm machine screw	STD.		10	30
3.	Socket head CSK screws M2x6mm machine screw	STD.		10	30
4.	M4 narrow spring washer	STD.		10	30
5.	Multigig RT Guide socket module	Part No. 1-1469492-9	M/s TE connectivity	2	6
6.	Backplane guide pin	Part No. 1410955-2	M/s TE connectivity	2	6
7.	Multigig socket cap screws	Part No. 1410946-1	M/s TE connectivity	2	6
8.	Anabond 652c, 100 gram heat sink compound	STD	NA	2	6
9.	LED Panel Mount Indicators	PM3HDLW9.0	BIVAR	2	6
10.	Wedge lock (Black anodized)	Part No426C-480UMB-CKP	M/s Wakefield- <u>Vette</u>	2	6

Drawing No.A-TR-01-A3

Sheet 2 of 2







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Bill of Material for GA Drawing No. A-BB-01-A3

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